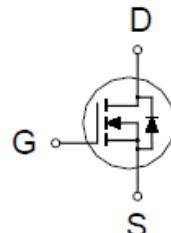
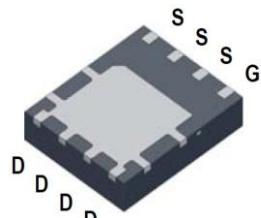
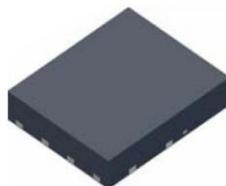


PK512BA

N-Channel Enhancement Mode MOSFET

PRODUCT SUMMARY

| $V_{(BR)DSS}$ | $R_{DS(ON)}$ | I_D^2 |
|---------------|------------------------|---------|
| 30V | 2.8mΩ @ $V_{GS} = 10V$ | 93A |



PDFN 5*6P

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ C$ Unless Otherwise Noted)

| PARAMETERS/TEST CONDITIONS | | SYMBOL | LIMITS | UNITS |
|--|---------------------|----------------|------------|-------|
| Drain-Source Voltage | | V_{DS} | 30 | V |
| Gate-Source Voltage | | V_{GS} | ± 20 | |
| Continuous Drain Current ² | $T_C = 25^\circ C$ | I_D | 93 | A |
| | $T_C = 100^\circ C$ | | 59 | |
| Pulsed Drain Current ¹ | | I_{DM} | 150 | A |
| Continuous Drain Current | $T_A = 25^\circ C$ | I_D | 22 | |
| | $T_A = 70^\circ C$ | | 17 | |
| Avalanche Current | | I_{AS} | 49 | |
| Avalanche Energy | $L = 0.1mH$ | E_{AS} | 120 | mJ |
| Power Dissipation | $T_C = 25^\circ C$ | P_D | 44 | W |
| | $T_C = 100^\circ C$ | | 17 | |
| Power Dissipation | $T_A = 25^\circ C$ | P_D | 2.5 | |
| | $T_A = 70^\circ C$ | | 1.6 | |
| Operating Junction & Storage Temperature Range | | T_J, T_{STG} | -55 to 150 | °C |

THERMAL RESISTANCE RATINGS

| THERMAL RESISTANCE | SYMBOL | TYPICAL | MAXIMUM | UNITS |
|----------------------------------|-----------------|---------|---------|--------|
| Junction-to-Case | $R_{\theta JC}$ | 3 | 50 | °C / W |
| Junction-to-Ambient ³ | $R_{\theta JA}$ | | | |

¹Pulse width limited by maximum junction temperature.

²Package limitation current is 52A

³The value of $R_{\theta JA}$ is measured with the device mounted on 1in² FR-4 board with 2oz.Copper, in a still air environment with $T_A=25^\circ C$

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ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ\text{C}$, Unless Otherwise Noted)

| PARAMETER | SYMBOL | TEST CONDITIONS | LIMITS | | | UNITS |
|---|-----------------------------|--|--------|------|-----------|------------------|
| | | | MIN | TYP | MAX | |
| STATIC | | | | | | |
| Drain-Source Breakdown Voltage | $V_{(\text{BR})\text{DSS}}$ | $V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$ | 30 | | | V |
| Gate Threshold Voltage | $V_{\text{GS}(\text{th})}$ | $V_{\text{DS}} = V_{\text{GS}}, I_D = 250\mu\text{A}$ | 1.5 | 1.75 | 2.35 | |
| Gate-Body Leakage | I_{GSS} | $V_{\text{DS}} = 0\text{V}, V_{\text{GS}} = \pm 20\text{V}$ | | | ± 100 | nA |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{\text{DS}} = 24\text{V}, V_{\text{GS}} = 0\text{V}$, | | | 1 | μA |
| | | $V_{\text{DS}} = 20\text{V}, V_{\text{GS}} = 0\text{V}, T_J = 55^\circ\text{C}$ | | | 10 | |
| Drain-Source On-State Resistance ¹ | $R_{\text{DS}(\text{ON})}$ | $V_{\text{GS}} = 4.5\text{V}, I_D = 16\text{A}$ | | 2.7 | 3.6 | $\text{m}\Omega$ |
| | | $V_{\text{GS}} = 10\text{V}, I_D = 20\text{A}$ | | 2.3 | 2.8 | |
| Forward Transconductance ¹ | g_{fs} | $V_{\text{DS}} = 5\text{V}, I_D = 20\text{A}$ | | 112 | | S |
| DYNAMIC | | | | | | |
| Input Capacitance | C_{iss} | $V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = 15\text{V}, f = 1\text{MHz}$ | | 3170 | | pF |
| Output Capacitance | C_{oss} | | | 369 | | |
| Reverse Transfer Capacitance | C_{rss} | | | 295 | | |
| Gate Resistance | R_g | $V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = 0\text{V}, f = 1\text{MHz}$ | | 0.8 | 1.5 | Ω |
| Total Gate Charge ² | Q_g | $V_{\text{GS}}=10\text{V}$ | | 65 | | nC |
| | | $V_{\text{GS}}=4.5\text{V}$ | | 34 | | |
| Gate-Source Charge ² | Q_{gs} | $V_{\text{DS}} = 15\text{V}, I_D = 20\text{A}, V_{\text{GS}} = 10\text{V}$ | | 9 | | nC |
| Gate-Drain Charge ² | Q_{gd} | | | 13 | | |
| Turn-On Delay Time ² | $t_{\text{d(on)}}$ | | | 29 | | nS |
| Rise Time ² | t_r | | | 13 | | |
| Turn-Off Delay Time ² | $t_{\text{d(off)}}$ | $V_{\text{DS}} = 15\text{V}, I_D \approx 20\text{A}, V_{\text{GS}}=20\text{V}, R_{\text{GEN}}=6\Omega$ | | 57 | | nS |
| Fall Time ² | t_f | | | 14 | | |
| SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS ($T_J = 25^\circ\text{C}$) | | | | | | |
| Continuous Current ³ | I_S | | | | 93 | A |
| Forward Voltage ¹ | V_{SD} | $I_F = 20\text{A}, V_{\text{GS}} = 0\text{V}$ | | | 1 | V |
| Reverse Recovery Time | t_{rr} | $I_F = 20 \text{ A}, dI_F/dt = 100\text{A}/\mu\text{s}$ | | 28 | | nS |
| Reverse Recovery Charge | Q_{rr} | | | 17 | | |

¹Pulse test : Pulse Width $\leq 300 \mu\text{sec}$, Duty Cycle $\leq 2\%$.

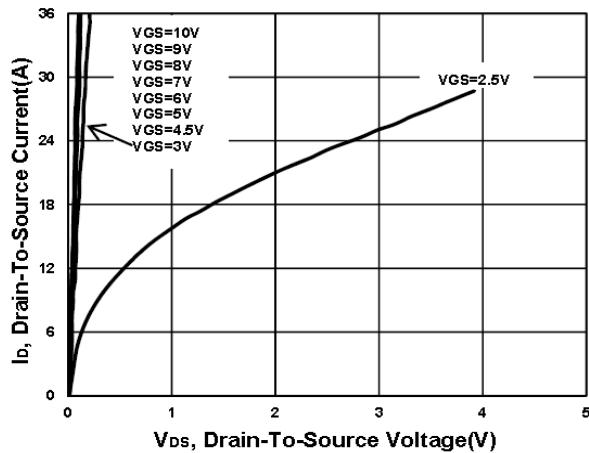
²Independent of operating temperature.

³Package limitation current is 52A

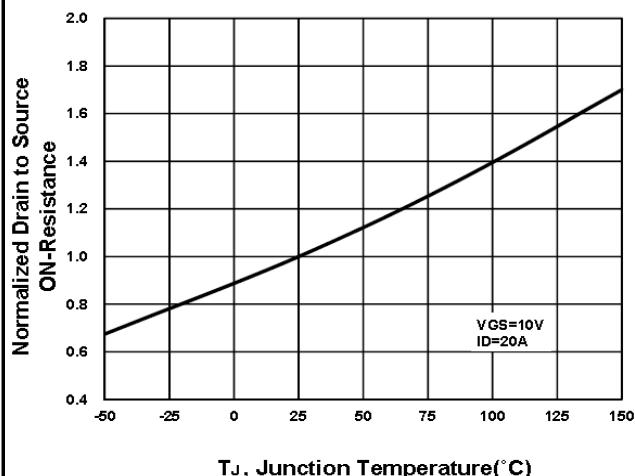
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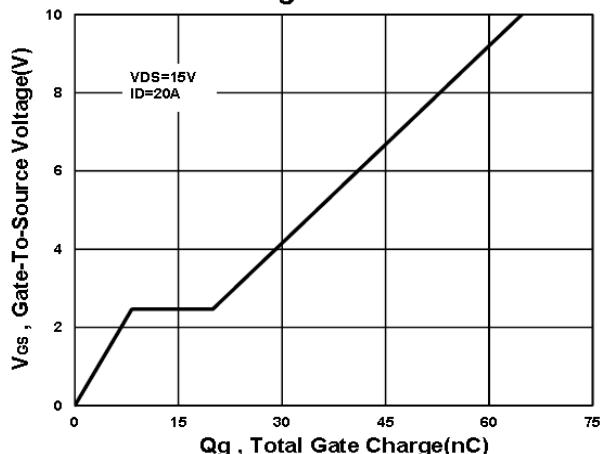
Output Characteristics



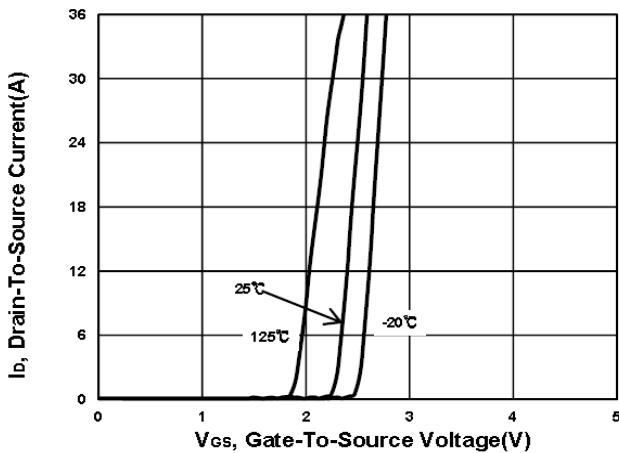
On-Resistance VS Temperature



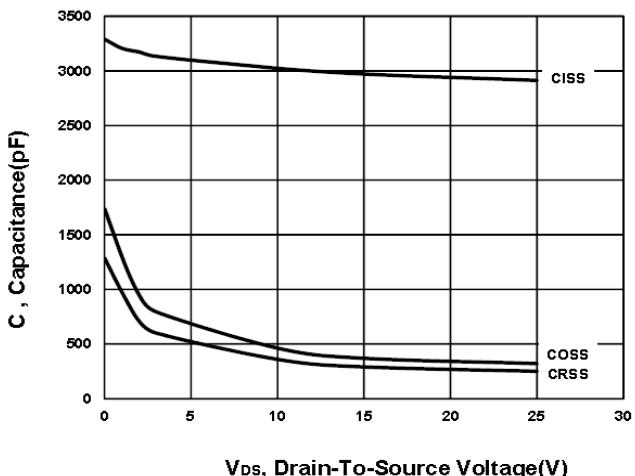
Gate charge Characteristics



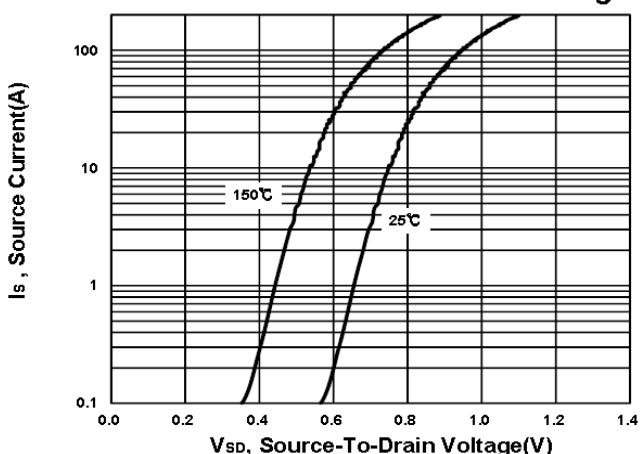
Transfer Characteristics



Capacitance Characteristic

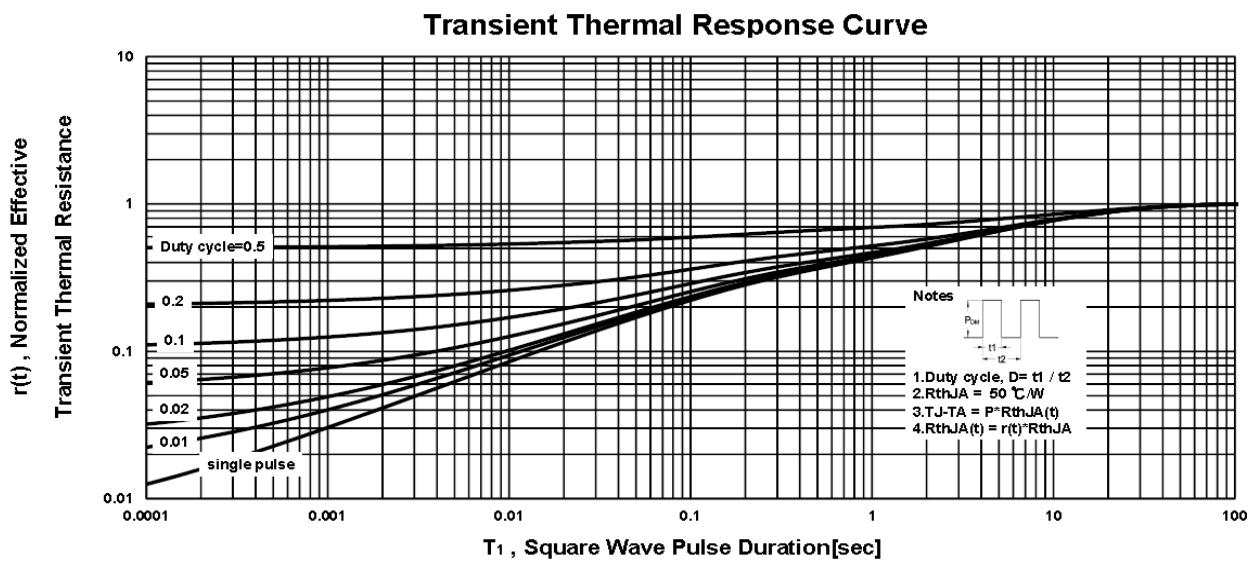
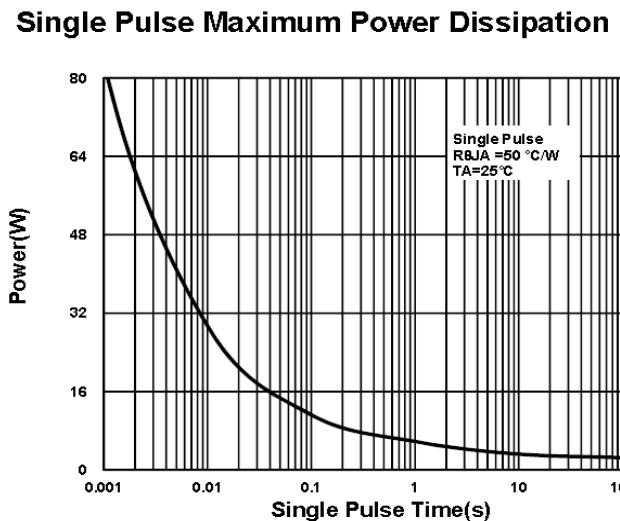
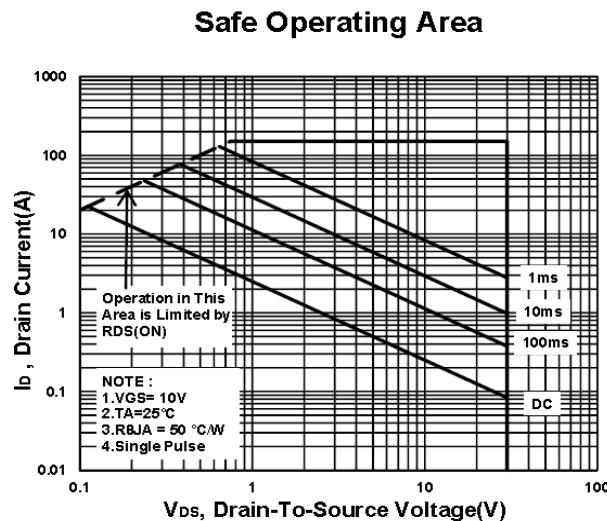


Source-Drain Diode Forward Voltage



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Package Dimension

PDFN 5x6P MECHANICAL DATA

| Dimension | mm | | | Dimension | mm | | |
|-----------|------|------|------|-----------|------|------|-------|
| | Min. | Typ. | Max. | | Min. | Typ. | Max. |
| A | 4.8 | | 5.15 | J | 3.33 | | 3.78 |
| B | 5.44 | | 5.9 | K | 0.9 | | |
| C | 5.9 | | 6.35 | L | 0.35 | | 0.712 |
| D | 0.33 | | 0.51 | M | 0° | | 12° |
| E | | 1.27 | | N | 4.8 | | 5.5 |
| F | 0.8 | | 1.25 | O | 0.05 | | 0.3 |
| G | 0.15 | | 0.34 | P | 0.06 | | 0.2 |
| H | 3.61 | | 4.31 | S | 3.69 | | 4.19 |
| I | 0.35 | | 0.71 | | | | |

